## FSUSB30

## Low Power 2－Port Hi－Speed USB 2.0 （480Mbps）Switch

## General Description

The FSUSB30 is a Low Power，2－Port Hi－Speed USB 2.0 switch．This part is configured as a DPDT switch and is optimized for switching between two Hi－Speed（480Mbps） sources or a Hi－Speed and Full Speed（12Mbps）source． The FSUSB30 is compatible with the requirements of USB2．0 and features an extremely low On Capacitance $\left(\mathrm{C}_{\mathrm{ON}}\right)$ of 6.5 pF ．The wide bandwidth of this device $(720 \mathrm{MHz})$ ，exceeds the bandwidth needed to pass the $3^{\text {rd }}$ harmonic，resulting in signals with minimum edge and phase distortion．Superior channel－to－channel crosstalk also minimizes interference．
The FSUSB30 contains special circuitry on the D＋／D－ pins which allows the device to withstand an overvoltage condition．This device is also designed to minimize cur－ rent consumption even when the control voltage applied to the S pin，is lower than the supply voltage $\left(\mathrm{V}_{\mathrm{CC}}\right)$ ．This feature is especially valuable to Ultra－Portable applica－ tions such as cell phones，allowing for direct interface with the General Purpose I／Os of the baseband proces－ sor．Other applications include switching and connector sharing in portable cell phones，PDAs，digital cameras， printers，and notebook computers．

## Features

■ Low On Capacitance，6．5pF（typical）
■ Low On Resistance， $6.5 \Omega$（typical）
－Low power consumption（ $1 \mu \mathrm{~A}$ maximum）
－ $10 \mu \mathrm{~A}$ maximum $\mathrm{I}_{\mathrm{CCT}}$ over and expanded control voltage range $\left(\mathrm{V}_{\mathrm{IN}}=2.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=4.3 \mathrm{~V}\right)$
■ Wide -3 dB bandwidth，$>720 \mathrm{MHz}$
■ 8KV ESD protection
－Power OFF protection when $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}$ ， $\mathrm{D}+/ \mathrm{D}$－pins can tolerate up to 4.3 V
■ Packaged in：
－Pb－Free 10－lead MicroPak ${ }^{\text {TM }}$（ $1.6 \mathrm{~mm} \times 2.1 \mathrm{~mm}$ ）
－Pb－Free 14－lead DQFN
－Pb－Free 10－lead MSOP（preliminary）

## Applications

－Cell phone，PDA，Digital Camera，and Notebook
■ LCD Monitor，TV，and Set－top Box

Ordering Information

| Order <br> Number | Package <br> Number | Package Description |
| :--- | :---: | :--- |
| FSUSB30L10X | MAC010A | Pb－Free 10－Lead MicroPak，1．6 mm x 2．1mm |
| FSUSB30BQX | MLP014A | Pb－Free 14－Terminal Depopulated Quad Very－Thin Flat Pack No Leads（DQFN）， <br> JEDEC MO－241，2．5 $\times 3.0 \mathrm{~mm}$ |
| FSUSB30MUX <br> （Preliminary） | MUA10A | 10－Lead Molded Small Outline Package（MSOP），JEDEC MO－187，3．0mm Wide |

Pb－Free package per JEDEC J－STD－020B．

## Application Diagram



MicroPak ${ }^{\mathrm{TM}}$ is a trademark of Fairchild Semiconductor Corporation．

## Connection Diagrams

Pad Assignments for MicroPak


Pad Assignments for DQFN

(Top Through View)

(Top Through View)

## Analog Symbol



Pin Descriptions

| Pin Name | Description |
| :---: | :---: |
| $\overline{O E}$ | Bus Switch Enable |
| S | Select Input |
| D+, D-, HSDn+, HSDn- | Data Ports |
| NC | No Connect |

Truth Table

| $\mathbf{S}$ | $\overline{\mathbf{O E}}$ | Function |
| :---: | :---: | :---: |
| $X$ | $H$ | Disconnect |
| $L$ | $L$ | $D+, D-=H S D 1_{n}$ |
| $H$ | $L$ | $D+, D-=H S D 2_{n}$ |

## Absolute Maximum Ratings

(The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.)

| Symbol | Parameter | Rating |
| :--- | :--- | ---: |
| $\mathrm{V}_{\text {CC }}$ | Supply Voltage | -0.5 V to +4.6 V |
| $\mathrm{~V}_{\text {CNTRL }}$ | DC Input Voltage ${ }^{1}$ | -0.5 V to +4.6 V |
| $\mathrm{~V}_{\text {SW }}$ | DC Switch Voltage ${ }^{1}$ |  |
|  | HSDnX |  |
|  | D+, D- | -0.5 V to $\mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}$ |
|  | DC Input Diode Current | -0.5 V to +4.6 V |
|  | DC Output Current | -50 mA |
|  | Storage Temperature | 50 mA |
|  | ESD (Human Body Model) | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
|  | All Pins | 8 KV |
|  | I/O to GND | 8 KV |

Recommended Operating Conditions ${ }^{2}$

| Symbol | Parameter | Rating |
| :--- | :--- | ---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply Voltage | 3.0 V to 4.3 V |
| $\mathrm{~V}_{\mathrm{IN}}$ | Control Input Voltage | 0 V to $\mathrm{V}_{\mathrm{CC}}$ |
|  | Switch Input Voltage | 0 V to $\mathrm{V}_{\mathrm{CC}}$ |
|  | Operating Temperature | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
|  | Thermal Resistance, 10 MicroPak | $250^{\circ} \mathrm{C} / \mathrm{W}$ |

## Notes:

1. The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed. DC switch voltage may never exceed 4.6V.
2. Control input must be held HIGH or LOW and it must not float.

DC Electrical Characteristics
(All typical values are @ $25^{\circ} \mathrm{C}$ unless otherwise specified.)

| Symbol | Parameter | Conditions | $\mathrm{V}_{\mathrm{cc}}(\mathrm{V})$ | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max |  |
| $\mathrm{V}_{\text {IK }}$ | Clamp Diode Voltage | $\mathrm{I}_{\mathrm{IN}}=-18 \mathrm{~mA}$ | 3.0 |  |  | -1.2 | V |
| $\mathrm{V}_{\text {IH }}$ | Input Voltage HIGH |  | 3.0 to 3.6 | 1.3 |  |  | V |
|  |  |  | 4.3 | 1.7 |  |  | V |
| $\mathrm{V}_{\text {IL }}$ | Input Voltage LOW |  | 3.0 to 3.6 |  |  | 0.5 | V |
|  |  |  | 4.3 |  |  | 0.7 | V |
| $\mathrm{I}_{\mathrm{N}}$ | Control Input Leakage | $\mathrm{V}_{\text {SW }}=0.0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{CC}}$ | 4.3 | -1.0 |  | 1.0 | $\mu \mathrm{A}$ |
| $\mathrm{l}_{\mathrm{Oz}}$ | OFF State Leakage | $0 \leq \mathrm{Dn}, \mathrm{HSD}_{1}, \mathrm{HSD2}_{\mathrm{n}} \leq \mathrm{V}_{\mathrm{CC}}$ | 4.3 | -2.0 |  | 2.0 | $\mu \mathrm{A}$ |
| IOFF | Power OFF Leakage Current (D+, D-) | $\mathrm{V}_{\mathrm{SW}}=0 \mathrm{~V}$ to 4.3V, $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}$ | 0 | -2.0 |  | 2.0 | $\mu \mathrm{A}$ |
| $\mathrm{R}_{\mathrm{ON}}$ | Switch On Resistance ${ }^{3}$ | $\mathrm{V}_{\mathrm{SW}}=0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{ON}}=-8 \mathrm{~mA}$ | 3.0 |  | 6.5 | 9.0 | $\Omega$ |
| $\Delta \mathrm{R}_{\text {ON }}$ | Delta R ${ }_{\text {ON }}{ }^{4}$ | $\mathrm{V}_{\mathrm{SW}}=0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{ON}}=-8 \mathrm{~mA}$ | 3.0 |  | 0.35 |  | $\Omega$ |
| $\mathrm{R}_{\text {ON }}$ Flatness | $\mathrm{R}_{\text {ON }}$ Flatness ${ }^{3}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{SW}}=0.0 \mathrm{~V}-1.0 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{ON}}=-8 \mathrm{~mA} \end{aligned}$ | 3.0 |  | 2.0 |  | $\Omega$ |
| $\mathrm{I}_{\mathrm{CC}}$ | Quiescent Supply Current | $\begin{aligned} & \mathrm{V}_{\mathrm{CNTRL}}=0.0 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{CC}}, \\ & \mathrm{l}_{\mathrm{OUT}}=0 \end{aligned}$ | 4.3 |  |  | 1.0 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {CCT }}$ | Increase in ICC Current per Control Voltage | $\mathrm{V}_{\text {CNTRL }}($ control input) $=2.6 \mathrm{~V}$ | 4.3 |  |  | 10.0 | $\mu \mathrm{A}$ |

## AC Electrical Characteristics

(All typical values are for $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} @ 25^{\circ} \mathrm{C}$ unless otherwise specified.)

| Symbol | Parameter | Conditions | $\mathrm{V}_{\mathrm{cc}}(\mathrm{V})$ | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | Units | Figure Number |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max |  |  |
| ton | Turn On Time S, OE to Output | $\begin{aligned} & H D 1_{n}, H D 2_{n}=0.8 \mathrm{~V}, \\ & R_{L}=50 \Omega, C_{L}=5 p F \end{aligned}$ | 3.0 to 3.6 |  | 13.0 | 30.0 | ns | Figure 8 |
| tofF | Turn OFF Time S, $\overline{\mathrm{OE}}$ to Output | $\begin{aligned} & \mathrm{HD} 1_{n}, \mathrm{HD} 2_{\mathrm{n}}=0.8 \mathrm{~V}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF} \end{aligned}$ | 3.0 to 3.6 |  | 12.0 | 25.0 | ns | Figure 8 |
| $t_{\text {PD }}$ | Propagation Delay ${ }^{4}$ | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}$ | 3.3 |  | 0.25 |  | ns | Figure 6 Figure 7 |
| $\mathrm{T}_{\text {BBM }}$ | Break-Before-Make | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \\ & \mathrm{~V}_{\mathrm{IN}}=0.8 \mathrm{~V} \end{aligned}$ | 3.0 to 3.6 | 2.0 |  | 6.5 | ns | Figure 9 |
| OIRR | OFF Isolation (Non-Adjacent) | $\mathrm{f}=240 \mathrm{MHz}, \mathrm{R}_{\mathrm{T}}=50 \Omega$ | 3.0 to 3.6 |  | -30.0 |  | dB | Figure 12 |
| Xtalk | Non-Adjacent Channel Crosstalk | $\mathrm{R}_{\mathrm{T}}=50 \Omega, \mathrm{f}=240 \mathrm{MHz}$ | 3.0 to 3.6 |  | -45.0 |  | dB | Figure 13 |
| BW | -3dB Bandwidth | $\mathrm{R}_{\mathrm{T}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=0 \mathrm{pF}$ | 3.0 to 3.6 |  | 720 |  | MHz | Figure 11 |
|  |  | $\mathrm{R}_{\mathrm{T}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}$ |  |  | 550 |  |  |  |

## Notes:

3. Measured by the voltage drop between Dn, HSD1 ${ }_{n}, \mathrm{HSD}_{\mathrm{n}}$ pins at the indicated current through the switch.

On Resistance is determined by the lower of the voltage on the two ports.
4. Guaranteed by characterization.

USB Hi-Speed Related AC Electrical Characteristics

| Symbol | Parameter | Conditions | $\mathrm{V}_{\mathrm{cc}}(\mathrm{V})$ | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | Units | Figure Number |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max |  |  |
| $\mathrm{t}_{\text {SK(O) }}$ | Channel-to-Channel Skew ${ }^{5}$ | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}$ | 3.0 to 3.6 |  | 50.0 |  | ps | Figure 6 Figure 10 |
| tsk(P) | Skew of Opposite Transitions of the Same Output ${ }^{5}$ | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}$ | 3.0 to 3.6 |  | 20.0 |  | ps | Figure 6 Figure 10 |
| $\mathrm{t}_{\mathrm{J}}$ | Total Jitter ${ }^{5}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \\ & \mathrm{t}_{\mathrm{R}}=\mathrm{t}_{\mathrm{F}}=500 \mathrm{ps} \text { at } 480 \mathrm{Mbps} \\ & \left(\text { PRBS }=2^{15}-1\right) \end{aligned}$ | 3.0 to 3.6 |  | 200 |  | ps |  |

Notes:
5. Guaranteed by characterization.

Capacitance

| Symbol | Parameter | Conditions | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | Units | Figure Number |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max |  |  |
| $\mathrm{C}_{\text {IN }}$ | Control Pin Input Capacitance | $V_{C C}=0 \mathrm{~V}$ |  | 1.5 |  | pF | Figure 15 |
| $\mathrm{C}_{\mathrm{ON}}$ | D1 $n$, D2 ${ }_{n}$, Dn ON Capacitance | $\mathrm{V}_{\mathrm{CC}}=3.3, \overline{\mathrm{OE}}=0 \mathrm{~V}$ |  | 6.5 |  | pF | Figure 14 |
| $\mathrm{C}_{\text {OFF }}$ | D1 ${ }_{\mathrm{n}}$, D2 ${ }_{\mathrm{n}}$ OFF Capacitance | $\mathrm{V}_{\mathrm{CC}}$ and $\overline{\mathrm{OE}}=3.3$ |  | 2.5 |  | pF | Figure 15 |

## Typical Characteristics



Figure 1. Gain vs. Frequency, $\mathrm{C}_{\mathrm{L}}=0 \mathrm{pF}, \mathrm{V}_{\mathrm{Cc}}=3.3 \mathrm{~V}$


Figure 2. OFF Isolation, $\mathrm{V}_{\mathrm{Cc}}=3.3 \mathrm{~V}$


Figure 3. Crosstalk, $\mathrm{V}_{\mathrm{Cc}}=3.3 \mathrm{~V}$

## Test Diagrams



Figure 4. On Resistance


Each switch port is tested separately.
Figure 5. OFF Leakage


Figure 7. Switch Propagation Delay Waveforms


Figure 8. Turn ON / Turn OFF Waveform


Figure 10. Switch Skew Tests


Figure 11. Bandwidth


Figure 12. Channel OFF Isolation


Figure 13. Non-Adjacent Channel-to-Channel Crosstalk


Figure 14. Channel ON Capacitance


Figure 15. Channel OFF Capacitance

Tape and Reel Specifications
Tape Format for MircoPak

| Package <br> Designator | Tape <br> Section | Number <br> Cavities | Cavity <br> Status | Cover Tape <br> Status |
| :---: | :---: | :---: | :---: | :---: |
| L10X | Leader (Start End) | 125 (typ) | Empty | Sealed |
|  | Carrier | 5000 | Filled | Sealed |
|  | Trailer (Hub End) | 75 (typ) | Empty | Sealed |

Tape Dimension inches (millimeters)


SCALE: 6X

Reel Dimension for MircoPak inches (millimeters)

Tape Format for DQFN

| Package <br> Designator | Tape <br> Section | Number <br> Cavities | Cavity <br> Status | Cover Tape <br> Status |
| :---: | :---: | :---: | :---: | :---: |
| BQX | Leader (Start End) | $125($ typ $)$ | Empty | Sealed |
|  | Carrier | $2500 / 3000$ | Filled | Sealed |
|  | Trailer (Hub End) | $75($ typ $)$ | Empty | Sealed |

Tap Dimensions inches (millimeters)


DIMENSIONS ARE IN MILLIMETERS
NOTES: unless otherwise specified

1. Cummulative pitch for feeding holes and cavities (chip pockets) not to exceed $0.008[0.20]$ over 10 pitch span.
2. Smallest allowable bending radius.
3. Thru hole inside cavity is centered within cavity.
4. Tolerance is $\pm 0.002[0.05]$ for these dimensions on all 12 mm tapes.
5. Ao and Bo measured on a plane $0.120[0.30]$ above the bottom of the pocket.
6. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
7. Pocket position relative to sprocket hole measured as true position of pocket. Not pocket hole.
8. Controlling dimension is millimeter. Diemension in inches rounded.

Reel Dimensions for DQFN inches (millimeters)


| Tape Size | $\mathbf{A}$ | $\mathbf{B}$ | $\mathbf{C}$ | $\mathbf{D}$ | $\mathbf{N}$ | W1 | W2 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 12 mm | 13.0 | 0.059 | 0.512 | 0.795 | 7.008 | 0.488 | 0.724 |
|  | $(330)$ | $(1.50)$ | $(13.00)$ | $(20.20)$ | $(178)$ | $(12.4)$ | $(18.4)$ |

Physical Dimensions inches (millimeters) unless otherwise noted

## Pb-Free 10-Lead MicroPak, $1.6 \mathrm{~mm} \times 2.1 \mathrm{~mm}$ Package Number MAC010A



BOTTOM VIEW

NOTES:
A. CONFORMS TO JEDEC REGISTRATION

MO-241, VARIATION AA
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

## MLP014ArevA

Pb-Free 14-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, $2.5 \times 3.0 \mathrm{~mm}$ Package Number MLP014A


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| ACEx ${ }^{\text {™ }}$ | FAST ${ }^{\circledR}$ | ISOPLANAR ${ }^{\text {™ }}$ | PowerSaver ${ }^{\text {TM }}$ | SuperSOTTM-6 |
| :---: | :---: | :---: | :---: | :---: |
| ActiveArray ${ }^{\text {TM }}$ | FASTr ${ }^{\text {TM }}$ | LittleFET ${ }^{\text {TM }}$ | PowerTrench ${ }^{\circledR}$ | SuperSOT ${ }^{\text {TM }}$-8 |
| Bottomless ${ }^{\text {TM }}$ | FPS ${ }^{\text {™ }}$ | MICROCOUPLER ${ }^{\text {™ }}$ | QFET ${ }^{\circledR}$ | SyncFET ${ }^{\text {™ }}$ |
| Build it $\mathrm{Now}^{\text {TM }}$ | FRFET ${ }^{\text {™ }}$ | MicroFET ${ }^{\text {™ }}$ | QS' ${ }^{\text {™ }}$ | TCM ${ }^{\text {™ }}$ |
| CoolFET ${ }^{\text {M }}$ | GlobalOptoisolator ${ }^{\text {TM }}$ | MicroPak ${ }^{\text {TM }}$ | QT Optoelectronics ${ }^{\text {TM }}$ | TinyLogic ${ }^{\circledR}$ |
| CROSSVOLT ${ }^{\text {TM }}$ | GTO ${ }^{\text {™ }}$ | MICROWIRE ${ }^{\text {™ }}$ | Quiet Series ${ }^{\text {™ }}$ | TINYOPTO ${ }^{\text {™ }}$ |
| DOME ${ }^{\text {TM }}$ | $\mathrm{HiSeC}^{\text {тм }}$ | MSX ${ }^{\text {™ }}$ | RapidConfigure ${ }^{\text {TM }}$ | TruTranslation ${ }^{\text {™ }}$ |
| EcoSPARK ${ }^{\text {TM }}$ | $\mathrm{I}^{2} \mathrm{C}^{\text {™ }}$ | MSXPro ${ }^{\text {™ }}$ | RapidConnect ${ }^{\text {TM }}$ | UHC ${ }^{\text {™ }}$ |
| $\mathrm{E}^{2} \mathrm{CMOS}^{\text {™ }}$ | $i-L o^{\text {TM }}$ | OCX ${ }^{\text {™ }}$ | $\mu$ SerDes ${ }^{\text {TM }}$ | UltraFET ${ }^{\circledR}$ |
| EnSigna ${ }^{\text {TM }}$ | ImpliedDisconnect ${ }^{\text {TM }}$ | OCXPro ${ }^{\text {тм }}$ | ScalarPump ${ }^{\text {TM }}$ | UniFET ${ }^{\text {m }}$ |
| FACT ${ }^{\text {™ }}$ | IntelliMAX ${ }^{\text {™ }}$ | OPTOLOGIC ${ }^{\circledR}$ | SILENT SWITCHER ${ }^{\circledR}$ | VCX ${ }^{\text {TM }}$ |
| FACT Quiet Series ${ }^{\text {TM }}$ |  | OPTOPLANAR ${ }^{\text {TM }}$ | SMART START ${ }^{\text {TM }}$ | Wire ${ }^{\text {TM }}$ |
|  |  | PACMAN ${ }^{\text {TM }}$ | SPM ${ }^{\text {™ }}$ |  |
| Across the board. Around the world. ${ }^{\text {TM }}$ |  | POP'м | Stealth ${ }^{\text {TM }}$ |  |
| The Power Franchise ${ }^{\circledR}$ |  | Power247 ${ }^{\text {TM }}$ | SuperFET ${ }^{\text {TM }}$ |  |
| Programmable Active Droop ${ }^{\text {TM }}$ |  | PowerEdge ${ }^{\text {TM }}$ | SuperSOT ${ }^{\text {TM }}$-3 |  |

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## PRODUCT STATUS DEFINITIONS

Definition of Terms

| Datasheet Identification | Product Status | Definition |
| :--- | :--- | :--- |
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